Electron transport in silicon nanowires: The role of acoustic phonon confinement and surface roughness scattering

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We investigate the effects of electron and acoustic phonon confinements on the low-field electron mobility of thin, gated, square silicon nanowires (SiNWs), surrounded by SiO2. We employ a self-consistent Poisson–Schrödinger–Monte Carlo solver that accounts for scattering due to acoustic phonons (confined and bulk), intervalley phonons, and the Si/SiO2 surface roughness. The wires considered have cross sections between $3 \times 3$ and $8 \times 8$ nm². For larger wires, the dependence of the mobility on the transverse field from the gate is pronounced, as expected. At low transverse fields, where phonon scattering dominates, scattering from confined acoustic phonons results in about a 10% decrease in the mobility with respect to the bulk phonon approximation. As the wire cross section decreases, the electron mobility drops because the detrimental increase in both electron-acoustic phonon and electron-surface roughness scattering rates overshadows the beneficial volume inversion and subband modulation. For wires thinner than $5 \times 5$ nm², surface roughness scattering dominates regardless of the transverse field applied and leads to a monotonic decrease in the electron mobility with decreasing SiNW cross section. © 2008 American Institute of Physics. [DOI: 10.1063/1.2977758]

I. INTRODUCTION

Among the emerging devices for the future technology nodes, silicon nanowires (SiNWs) have attracted much attention among researchers due to their potential to function as thermoelectric (TE) coolers,1,2 logic devices3,4 interconnects,5,6 photodetectors,7 as well as biological and chemical sensors. Although considerable work has recently been done on SiNWs,8–10 there is no consensus on these structures’ electronic properties.

The low-field electron mobility is one of the most important parameters that determines the performance of field-effect transistors (FETs), TE coolers, and sensors. Although its importance in ultrashort channel metal-oxide-semiconductor FETs (MOSFETs) has been debated11,12 it certainly affects the conductivity of the wire interconnects, the figure of merit of TE coolers, and the responsiveness of nanowire sensors. The study of the electron mobility in SiNWs so far has been inconclusive: Kotlyar et al.9 and Jin et al.10 showed that the mobility in a cylindrical SiNW decreases with decreasing wire diameter, whereas the works of Sakaki,13 Cui et al.,8 and Koo et al.14 showed higher mobility in SiNWs compared to bulk MOSFETs. The contradiction stems from two opposing effects that determine the electron mobility as we move from two-dimensional (2D) to one-dimensional (1D) structures: one is a decrease in the density of states (DOS) for scattering13 that results in reduced scattering rates and thereby an enhancement in the mobility; the second is an increase in the so-called electron phonon wavefunction overlap13 that results in increased electron phonon scattering rates and consequently lower mobility. While important, these two competing phenomena do not paint a full picture of low-field transport in SiNWs, in which the effect of spatial confinement on the scattering due to surface roughness and acoustic phonons must be addressed.

Surface roughness scattering (SRS) is by far the most important cause of mobility degradation in conventional MOSFETs at high transverse fields. Intuitively, one would expect the SRS to be even more detrimental in SiNWs than in conventional MOSFETs because SiNWs have four Si/SiO2 interfaces, as opposed to one such interface in conventional MOSFETs. Although recent work has shown that the SRS is, in fact, less important in SiNWs than in bulk MOSFETs due to a reduction in the DOS (Ref. 15) and the onset of volume inversion (redistribution of electrons throughout the silicon channel),16 a detailed study of the SRS-limited mobility in cylindrical SiNWs by Jin et al.10 showed a rapid monotonic decrease in mobility for wire diameters smaller than 5 nm.

Scattering due to acoustic phonons is significantly altered in nanostructures due to the modification of the acoustic phonon spectrum in them. Extensive work on the effects of acoustic phonon confinement in III–V based nanostructures17,18 shows a lower acoustic phonon group velocity,19,20 lower thermal conductivity,21–23 and increased acoustic phonon scattering rates24,25 in nanoscale devices compared to their bulk counterparts. As for silicon nanostructures, there is experimental evidence of the acoustic phonon confinement in nanomembranes,26 while recent works on silicon-on-insulator (SOI) MOSFETs (Refs. 27–29)
and SiNWs (Ref. 30) also show that the bulk phonon (linear dispersion) approximation underestimates the scattering rates.

In this work, we calculate the electron mobility of gated square SiNWs by using a self-consistent 2D Schrödinger–2D Poisson–1D Monte Carlo simulator and accounting for electron scattering due to acoustic phonons (confined and bulk), intervalley phonons, and imperfections at the Si/SiO₂ interface. The wires considered have cross sections between \( 3 \times 3 \) and \( 8 \times 8 \) nm\(^2\). Bulk-silicon effective mass parameters are used in the calculation of the scattering rates. The confined acoustic phonon spectrum is obtained by using the \( xyz \) algorithm\(^{31,32} \) and the unscreened SRS is modeled using the modified model of Ando et al.\(^{33} \) that accounts for the finite thickness of the silicon layer. For larger wires, as expected, the dependence of the mobility on the transverse field from the gate is pronounced; at low transverse fields, where phonon scattering dominates, scattering from confined acoustic phonons results in about a 10% decrease in the mobility with respect to the bulk phonon approximation. As the wire cross section decreases, the electron mobility drops because the detrimental increase in both electron-acoustic phonon and electron-SRS rates overshadows the beneficial effects of volume inversion (redistribution of electrons in real space)\(^{16,34} \) and subband modulation (redistribution of electrons among different subbands).\(^{35–37} \) For wires thinner than \( 5 \times 5 \) nm\(^2\), SRS dominates regardless of the transverse field applied and leads to a monotonic decrease in the electron mobility with decreasing SiNWs cross section.

The electronic band structure in SiNWs is altered from that of bulk silicon due to the Brillouin zone folding.\(^{30,38,39} \) The degeneracy of the conduction band minima in SiNWs is split; \( \Delta_4 \) valleys (four degenerate \( \Delta \) valleys whose long axis is perpendicular to the SiNW axis) are found to be at the \( \Gamma \) point and the \( \Delta_2 \) valleys (two degenerate \( \Delta \) valleys whose long axis is parallel to the SiNW axis) are at \( k_c = \pm 0.37 \pi/a \). The band structure modification will certainly affect the intervalley scattering rates in SiNWs, but deformation potentials and phonon energies needed to describe the intervalley scattering are still only available for bulk silicon. Therefore, in order to be consistent, we do not employ the exact nanowire band structure but rather rely on the bulk Si band structure and then solve the 2D Schrödinger equation within the envelope function and effective mass framework, with the bulk Si effective mass parameters. This approximation was proven adequate down to the 3 nm wire diameter.\(^{38} \) The splitting of the sixfold degenerate \( \Delta \) valleys of bulk silicon into \( \Delta_2 \) and \( \Delta_4 \) upon confinement is automatically accounted for by including the anisotropy of the electron effective mass (see Sec. III A).

This paper is organized as follows: Sec. II describes the device structure used in this study and the components of the simulator developed to calculate the mobility. A description of the acoustic phonon spectrum calculation in SiNWs is given toward the end of Sec. II. In Sec. III, we emphasize the importance of accounting for the acoustic phonon confinement when calculating the mobility in SiNWs and then present the results for the variation of mobility in square SiNWs with increasing spatial confinement. We conclude this paper with a brief summary of the findings of our work (Sec. IV) and a detailed derivation of the scattering rates due to acoustic phonons, intervalley phonons, and surface roughness (Appendixes A and B).

II. MOBILITY CALCULATION

A. Device structure and simulator components

A schematic of the device considered in our study is shown in Fig. 1. It is a modified version of the ultrathin, ultranarrow SOI MOSFET that was originally proposed by Majima et al.\(^{40} \) The thickness of the gate oxide, buried oxide, and bottom silicon substrate are 25 nm, 80 nm, and 700 nm, respectively. The transverse dimensions of the silicon channel are varied from \( 8 \times 8 \) to \( 3 \times 3 \) nm\(^2\). For all the device cross sections considered, the width of the oxide on both sides of the channel is 200 nm, the channel is doped to \( 3 \times 10^{15} \) cm\(^{-3}\), and the channel is assumed to be homogeneous and infinitely long.

The simulator developed to calculate the electron mobility has two components: the first is a self-consistent 2D Poisson–2D Schrödinger solver and the second is a 1D Monte Carlo transport kernel. The former is used to calculate the electronic states and the self-consistent potential distribution along the cross section of the wire and the latter simulates the transport along the wire axis. The finite barrier at the Si/SiO₂ interface results in the electron wavefunction penetration through the interface and into the oxide. The wavefunction penetration is accounted for by including a few mesh points in the oxide while solving the Schrödinger equation. ARPACK package\(^{41} \) was used to solve the 2D Schrödinger equation and the successive over-relaxation (SOR) method was used to solve the 2D Poisson equation. The convergence of the coupled 2D Schrödinger–2D Poisson solver is found to be faster when the Poisson equation is solved by using the SOR method than when the incomplete lower-upper decomposition method is used.

The Monte Carlo transport kernel is used to simulate the electron transport along the axis of the wire under the influence of the confining potential in the transverse directions and a very small lateral electric field along the channel. The long wire approximation implies that the transport is diffusive (the length exceeds the carrier mean free path), and
therefore justifies the use of the Monte Carlo method\textsuperscript{42,43} to simulate electron transport. Electrons are initialized such that their average kinetic energy is \((1/2)K_p T\) (thermal energy for 1D) and are distributed among different subbands in accordance with the equilibrium distribution of the states obtained from the Poisson–Schrödinger solver. Since the electrons are confined in two transverse directions, they are only scattered in either the forward or the backward direction; consequently, just the carrier momentum along the length of the wire needs to be updated after each scattering event. Mobility is calculated from the ensemble average of the electron velocities.\textsuperscript{42}

**B. Scattering due to bulk acoustic phonons, intervalley phonons, and surface roughness**

Phonon scattering and the SRS are considered in this work. The SRS was modeled using the model of Ando et al.,\textsuperscript{33} intervalley scattering was calculated using bulk phonon approximation, and the intravalley acoustic phonons were treated in both the bulk-mode and confined-mode approximations. Since the wire is very lightly doped, the effect of impurity scattering was not included. Nonparabolic band model for silicon, with the nonparabolicity factor \(\alpha =0.5\) eV\(^{-1}\), was used in the calculation of scattering rates. A detailed derivation of the 1D scattering rates is given in Appendix A (phonon scattering) and Appendix B (SRS). Here, for brevity, only the final expressions for the scattering rates are given.

For an electron with an initial lateral wavevector \(k_x\) and parabolic kinetic energy \(E_n=\hbar^2k_x^2/(2m^*)\) in subband \(n\) [with subband energy \(E_n\) and electron wavefunction \(\psi_n(y,z)\)], scattered to subband \(m\) [with subband energy \(E_m\) and electron wavefunction \(\psi_m(y,z)\)], the final kinetic energy \(E_f\) is given by

\[
E_f = E_n - E_m + \frac{\sqrt{1+4\alpha E_n}}{2\alpha} + \hbar\omega,
\]

where \(\hbar\omega=0\) for elastic (bulk intravalley acoustic phonon and surface roughness) scattering, \(\hbar\omega=\pm \hbar\omega_0\) for the absorption/emission of an approximately dispersionless intervalley phonon of energy \(\hbar\omega_0\), while in the case of confined acoustic phonons (below) the full phonon subband dispersion is incorporated.

The intravalley acoustic phonon scattering rate due to bulk acoustic phonons is given by

\[
\Gamma_{nm}^{\text{ac}}(k_x) = \Xi_{ac} \frac{\hbar k_x T \sqrt{2m^*}}{\hbar^2 \rho \omega_0^2} \frac{D_{nm}}{\sqrt{E_f(1+\alpha E_f)}} \Theta(E_f),
\]

where \(\Xi_{ac}\) is the acoustic deformation potential, \(\rho\) is the crystal density, \(v\) is the sound velocity, and \(\Theta\) is the Heaviside step function. \(D_{nm}\) represents the overlap integral associated with the electron phonon interaction (the so-called electron phonon wavefunction integral\textsuperscript{34}), and is given by

\[
D_{nm} = \iiint |\psi_n(y,z)|^2 |\psi_m(y,z)|^2 d y d z.
\]

The intervalley phonon scattering (mediated by short wavelength acoustic and optical phonons) rate is given by

\[
\Gamma_{nm}^{\text{opt}}(k_x) = \frac{\Xi_{m}^2}{\sqrt{2 \hbar \rho \omega_0}} \left( N_0 + \frac{1 + \frac{1}{2}}{2} \right) D_{nm}
\]

\[
\times \left( 1 + 2\alpha E_f \right) \Theta(E_f),
\]

where \(\Xi_{m}\) is the intervalley deformation potential, and \(D_{nm}\) is defined in Eq. (3). The approximation of dispersionless bulk phonons of energy \(\hbar \omega_0\) was adopted to describe an average phonon with wavevector near the edge of the Brillouin zone and \(N_0=[\exp(\hbar \omega_0/k_BT)-1]^{-1}\) is their average number at temperature \(T\).

Assuming exponentially correlated surface roughness\textsuperscript{44} and incorporating the electron wavefunction deformation due to the interface roughness using the model of Ando et al.,\textsuperscript{33} the unscreened SRS rate is given by

\[
\Gamma_{nm}^{\text{sr}}(k_x, \pm) = \frac{2\sqrt{\hbar^2 m^*}}{\Delta \Lambda} \left[ \frac{\Delta}{\hbar^2} + (q_s^x)^2 \Lambda^2 \right] |F_{nm}|^2
\]

\[
\times \left( 1 + 2\alpha E_f \right) \Theta(E_f),
\]

where \(\Delta\) and \(\Lambda\) are the rms height and the correlation length of the fluctuations at the Si–SiO\(_2\) interface, respectively. \(q_s^x = k_x \pm k'_x\) is the difference between the initial \((k_x)\) and the final \((k'_x)\) electron wavevectors and the top (bottom) sign is for backward (forward) scattering. The SRS overlap integral in Eq. (5) due to the top interface for a silicon body thickness of \(t_z\) is given by

\[
F_{nm} = \iiint d y d z \left[ -\frac{\hbar^2}{\epsilon} \frac{\psi_m(y,z) \partial^2 \psi_m(y,z)}{\partial y^2} + \psi_n(y,z) \frac{1 - y}{t_z} \psi_m(y,z) + \psi_n(y,z) \frac{1 - y}{t_z} \psi_m(y,z) \right]
\]

\[
\times \left( \frac{E_m - E_n}{e} \right) \left( 1 - \frac{y}{t_z} \right) \frac{\partial \psi_m(y,z)}{\partial y}.\]

The SRS overlap integral was derived assuming the interfaces to be uncorrelated. For the bottom interface, the integration should be performed from the bottom interface to the top interface and the integral for the side interfaces can be obtained by interchanging \(y\) and \(z\) in Eq. (6). The first term in Eq. (6) is the confinement-induced part of the SRS and it increases with decreasing wire cross section. This term does not depend on the position of the electrons in the channel and hence results in high SRS even at low transverse fields from the gate. The second and third terms in Eq. (6) depend on the average distance of electrons from the interface, so they contribute to the SRS only at high transverse fields from the gate. (In Sec. III, for example, we will see that the major contribution to the SRS in wires thinner than
Scattering rates given by Eqs. (2)–(5) are calculated using the wavefunctions and potential obtained from the self-consistent Poisson–Schrödinger solver. For this work, the parameters used for calculating the intervalley scattering were taken from Ref. 35, the acoustic deformation potential was taken from Ref. 30, and $\Delta=0.3$ nm and $\Lambda=2.5$ nm were used to characterize the SRS due to each of the four interfaces. The SRS parameters were obtained by fitting the mobility of an $8 \times 8$ nm$^2$ SiNW in the high transverse field region (where the SRS dominates) with the corresponding mobility observed in ultrathin SOI of similar thickness.37

**C. Acoustic phonon confinement**

In ultrathin and ultranarrow structures, the acoustic phonon spectrum is modified due to a mismatch of the sound velocities and mass densities between the active layer and the surrounding material,20,45 in our case, silicon and SiO$_2$. This modification in the acoustic phonon spectrum becomes more pronounced as the dimensions of the active layer become smaller than the phonon mean free path, which is around 300 nm in silicon.46 Pokatilov et al.20 showed that the modification in the acoustic phonon dispersion in nanowires can be characterized by acoustic impedance $\zeta = \rho V_s$, where $\rho$ and $V_s$ are the mass density and sound velocity in the material, respectively. By considering materials with different $\zeta$, Pokatilov et al.20 showed that the acoustic phonon group velocity in the active layer is reduced when an acoustically soft (smaller $\zeta$) material surrounds an active layer made of acoustically hard (higher $\zeta$) material. Since Si is acoustically harder than SiO$_2$, the acoustic phonon group velocity in SiNWs with SiO$_2$ barriers decreases and results in an increased acoustic phonon scattering rate [see Eq. (2)].

**1. Confined acoustic phonon dispersion**

The first step in accounting for the acoustic phonon confinement in mobility calculation is to calculate the modified acoustic phonon dispersion. Using the adiabatic bond charge model17 (microscopic calculation, accurate but computationally involved), Heppestone and Srivastava46 showed the validity of the elastic continuum model (macroscopic calculation, less accurate but easier to implement) for wire dimensions greater than 2.5 nm. Hence, in this work we have used the elastic continuum model to calculate the modified phonon spectrum. Most of the previous studies of acoustic phonon confinement in nanowires have used approximate hybrid modes proposed by Morse89 (valid for wires with thickness much smaller than the width) to calculate the dispersion spectrum. Nishiguchi et al.32 calculated the dispersion spectrum using the $xyz$ algorithm31 and found that the Morse formalism is valid only for the lowest phonon subband. Since one acoustic phonon subband is certainly not enough to accurately describe scattering with electrons, in this work, we have used the approach of Nishiguchi et al. to calculate the acoustic phonon dispersion although it is computationally intensive. The basis functions used to expand

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**FIG. 2.** (Color online) Confined acoustic phonon dispersion (dilatational mode) calculated using the $xyz$ algorithm (Ref. 32) for an $8 \times 8$ nm$^2$ SiNW. Only the lowest ten phononic subbands are shown. Dispersion in the first one-third of the first Brillouin zone is shown for clarity.
2. Scattering due to confined acoustic phonons

The modification of the acoustic phonon dispersion due to confinement, shown in Fig. 2, implies that the linear dispersion and elastic scattering approximation can no longer be used in calculating the scattering rate. The modified scattering rate which takes into account confined acoustic phonon modes is given by

\[ \Gamma_{mn}(k_x) = \frac{\pi^2}{2W} \sum_{j=1,2} \left( N_j q_x + \frac{1}{2} \pm \frac{1}{2} \right) \times \frac{1}{\omega_f(q_x)} |\chi_{lm} q_x \rangle | g'(q_x) |^2, \]  

where \( q_x \) is the lateral wavevector of the acoustic phonon, \( g(q_x) = E - E' + h\omega_f(q_x) \), \( q_x^l \) and \( q_x^r \) are the two possible roots of \( g(q_x) = 0 \), and \( g'(q_x) \) and \( g''(q_x) \) are the derivatives of \( g(q_x) \) with respect to \( q_x \), evaluated at \( q_x^l \) and \( q_x^r \), respectively. Index \( J \) stands for the different acoustic phonon modes and \( N_{q_x} \) is the number of acoustic phonons of energy \( \hbar \omega_f(q_x) \). Overlap integral \( \mathcal{L}_{mn}(J, q_x) \) and the total energy of the electron before \( (E) \) and after \( (E') \) scattering are defined in Appendix A 3. \( \chi_{lm} \) is the eigenvector corresponding to \( \omega_f(q_x) \) (for details, see Appendix A 3).

For intrasubband transitions, only dilatational modes are important because for all other modes the overlap integral \( \mathcal{L}_{mn}(J, q_x) \) in Eq. (7) vanishes due to symmetry. In intersubband transitions, all the four sets of acoustic phonon modes are included in the calculation of the electron-confined acoustic phonon scattering rates, but the dominant contribution to the scattering rate comes from the dilatational modes. Figure 3 shows the intrasubband electron-acoustic phonon scattering rate for the lowest electron subband, calculated using both the bulk-mode and confined-mode approximations. When calculating the electron-bulk acoustic phonon scattering rates, acoustic phonon dispersion is assumed to be linear, \( \omega_f = V_s q_x \), where \( V_s \) is the sound velocity, as before. The resulting scattering rate, in the elastic and equipartition approximations (see Appendix A 1), is proportional to the final electron density of states, and has the characteristic 1D DOS peaks (dot-dashed green line) whenever the electron energy becomes sufficient to scatter into the next subband. In the case of confined acoustic phonons, as seen in Fig. 2, the elastic approximation for electron-phonon scattering no longer holds and neither does the linear dispersion at small wavevectors (except for the lowest phonon subband). Still, one can speak of a group velocity associated with a collection of phononic subbands. The average group velocity accounting for the nonuniform energy gap between different phonon modes is shown in Fig. 4. The average group velocity is close to the bulk value for very small phonon energies, but asymptotically reaches a constant value (less than 50% of its bulk value) at high phonon energies. Since the scattering rate due to confined phonon subbands is inversely proportional to their group velocity, on average, the confined acous-

![FIG. 3. (Color online) Electron-acoustic phonon scattering rate for the lowest electron subband of an 8×8 nm² SiNW at the channel sheet density of \( N_c = 8.1 \times 10^{11} \) cm⁻², calculated assuming the bulk (dash-dot green line) and confined phonons (solid red line). The electron-bulk acoustic phonon intersubband spikes are at around 20, 52, 85, and 95 meV, and they correspond to the electron scattering from the lowest subband to the second, third, fourth, and the fifth subbands, respectively. To the left/right of each intersubband scattering spike that corresponds to the bulk phonon approximation (dash-dot green) are two groups of small spikes (solid red) that correspond to absorption ("ab")/emission ("em") of confined phonons from different phonon subbands.

![FIG. 4. (Color online) Group velocity of dilatational modes for an 8×8 nm² SiNW. On average, acoustic phonon group velocity is reduced to less than 50% of the bulk value (9.13×10⁵ cm/s).]
width in 8 nm thick rectangular SiNW of different widths and observed two that (i) the mobility at low-to-moderate transverse fields, limited by phonon scattering, decreases with decreasing wire width, and (ii) the mobility at high transverse fields, which is dominated by the SRS, increases with decreasing wire width. The former is due to the increase in the electron phonon wavefunction overlap [Eq. (3)] with decreasing wire width, and the latter is due to the onset of volume inversion. In this section, we first emphasize the importance of acoustic phonon confinement in SiNWs, and then vary the cross section of the wire to investigate the effect of increasing spatial confinement on electron mobility.

The electron mobility in an $8 \times 8$ nm$^2$ wire, with and without phonon confinement, is shown in Fig. 5. In the low-transverse-field region, the mobility calculated with confined acoustic phonons is about 10% lower than that obtained with bulk phonons. This clearly indicates that confined acoustic phonons need to be properly included in the study of electrical transport in SiNWs. The mobility values for $8 \times 8$ nm$^2$ are very close to the experimentally observed mobility in ultrathin SOI of similar thickness. In the remainder of the article, we will always assume confined acoustic phonons.

To determine the cross sectional dependence of the electron mobility in SiNWs and to understand the confinement effects on the spatial and $k$-space distribution of electrons, the cross section of the wire was varied from $8 \times 8$ to $3 \times 3$ nm$^2$. The variations of the electron mobility with decreasing wire cross section at a low ($1.4 \times 10^{-2}$ MV/cm), moderate ($2.4 \times 10^{-1}$ MV/cm), and high (1.04 MV/cm) transverse field are plotted in Fig. 6. In the following, we will see that a complex interplay of several competing physical mechanisms is responsible for the electron mobility behavior observed in Fig. 6.

A. Subband modulation

One of the most important factors that determine the energy and occupation probability of a subband in each of the $\Delta_6$ valleys (equivalent in bulk silicon) is the effective mass in the direction of confinement. For the SiNWs considered, the confinement is along the $y$ and $z$ directions and the electrons are allowed to move freely in the $x$ direction; consequently, the conductivity effective mass for the valley pairs with minima on the $x$, $y$, and $z$ axes are $m_x$, $m_y$, and $m_z$, respectively, while their subband energies are roughly proportional to $1/\sqrt{m_x}$, $1/\sqrt{m_y}$, and $1/\sqrt{m_z}$, respectively. Since $m_y < m_z$, the subbands in the valley pair along $x$ are higher in energy than those in the valley pairs along $y$ and $z$. So the subbands split into those originating from the twofold degenerate $\Delta_2$ (the valley pair along $x$) and those originating from the fourfold degenerate $\Delta_4$ valleys (the valley pairs along $y$ and $z$).

Upon increasing spatial confinement by decreasing the wire cross section, the subbands in different valleys are pushed higher up in energy, and consequently only a few of the lowest subbands in each of the valley pairs get populated with electrons. Figure 7 shows the depopulation of the higher $\Delta_2$ valley subbands with increasing spatial confinement: since the lowest subbands in the $\Delta_4$ valleys are lower in energy than those in the $\Delta_2$ valleys, under extreme confinement $\Delta_2$ subbands get completely depopulated, and only the lowest $\Delta_4$ subbands are populated. Splitting the valley degeneracy and modification of the subband energies in different valley pairs due to spatial confinement, followed by depopulation of the higher subbands, are together termed subband modulation. Subband modulation enhances the electron mobility because it suppresses intersubband and intervalley scattering, as shown for ultrathin-body SOI MOSFETs. In our previous work on SiNWs, we also observed a small enhancement in mobility for wires of cross section around $4 \times 4$ nm$^2$, but in that study we did not consider the confinement-induced term in SRS. However, this...
The big picture

B. Volume inversion

As the cross section of the SiNW decreases, the channel electrons are distributed throughout the silicon volume, as opposed to just within a thin channel at the Si/SiO₂ interface right below the gate in conventional MOSFETs. The transition from surface inversion to volume inversion occurs gradually and the cross section at which the entire silicon is inverted depends on the electron sheet density. Figure 8 shows the variation of the electron density across the wire with varying wire dimensions (gate is on top). When the cross section is decreased from 8 × 8 nm² (bottom right panel) to about 6 × 6 nm² (bottom left panel), the onset of volume inversion results in an increase in the average distance of the electrons from the top interface, where the electric field is highest, so SRS is reduced [the second and third terms in the SRS overlap integral (6) drop with a decrease in the average electronic position from the interface, and are therefore sensitive to volume inversion]. However, once the wire cross section reaches about 5 × 5 nm², the silicon volume is fully inverted so further reduction in the cross section simply results in a decrease in the average distance of the electrons from the interfaces (all four of them), thereby resulting in more SRS. Consequently, for wires with the cross section smaller than 5 × 5 nm², volume inversion does not offer an advantage to electronic transport.

C. Mobility variation with the SiNW cross section: The big picture

Figure 6 shows the variation of the electron mobility when the SiNW cross section is varied from 8 × 8 to 3 × 3 nm², for a high (red), moderate (blue), and low (green) transverse electric field from the gate.

1. Low and moderate transverse fields

With decreasing wire cross section, the intrasubband phonon scattering increases due to the increase in the electron phonon overlap integral (Fig. 9); intersubband scattering and intervalley phonon scattering decrease due to subband modulation; SRS increases due to the increase in the first term in the SRS overlap integral with increasing confinement. Overall, the mobility decreases with decreasing wire cross section, very weakly for larger wires and much more rapidly for wires roughly smaller than about 5 × 5 nm². As the wire cross section increases above 7 × 7 nm², we observe a very weak mobility variation that results from the competition between an increase in intersubband scattering (number of occupied subbands increases) and a decrease in intrasubband scattering (electron phonon overlap integral decreases). A similar weak dependence of the electron mobility with increasing cross section was reported by Jin et al. for cylindrical SiNWs with diameters greater than 6 nm.

2. High transverse fields

As the wire cross section is reduced from 8 × 8 to 5 × 5 nm², the first term in the SRS overlap integral (6) increases, whereas the second and third terms decrease due to the onset of volume inversion (Fig. 8). Consequently, the mobility shows a very small change for these cross sections. However, when the wire cross section is smaller than 5 × 5 nm², the benefits of volume inversion are lost and all the terms in the SRS overlap integral increase with decreasing wire cross section.

3. Transverse field independence of the electron mobility for very thin wires

We also notice that the transverse field dependence of the electron mobility weakens with decreasing wire cross section and becomes virtually unimportant for SiNWs thinner than about 5 × 5 nm². Irrespective of the effective field from the gate, the mobility decreases monotonically with increasing spatial confinement, with the limiting mechanisms being the steady increase in the field-independent, confinement-induced part of the SRS (6) and the increase in...
intrasubband phonon scattering. Of these two mechanisms that limit the electron mobility in ultrathin wires, the SRS scattering dominates.

IV. CONCLUSION

In ultrathin SiNWs, both electrons and acoustic phonons experience 2D confinement. In wires surrounded by SiO₂, an acoustically softer material, the acoustic phonon group velocity is lowered to almost half of its bulk silicon value, and leads to enhanced electron-acoustic phonon scattering rates. The electron mobility calculated while accounting for the acoustic phonon confinement when calculating the electrical properties of SiNWs. This result clearly emphasizes the need to account for the acoustic phonon confinement when calculating the properties of SiNWs.

We systematically account for confined acoustic phonons in the calculation and find that the mobility decreases with decreasing wire cross section, very weakly for thicker wires and much more rapidly for wires roughly thinner than about 5 × 5 nm². Also, we find that the transverse field dependence of the electron mobility weakens with decreasing wire cross section and becomes virtually unimportant for SiNWs thinner than about 5 × 5 nm².

For thicker wires at low and moderate transverse fields, the slow decrease in mobility with decreasing wire cross section is governed primarily by the interplay between the beneficial subband modulation (less intersubband and intervalley scattering) and the detrimental increase in intrasubband scattering. At higher fields, however, the weak mobility variation with decreasing cross section stems from the competing influences of the beneficial volume inversion and the detrimental enhancement of the confinement-induced SRS term.

For very thin wires (below the 5 × 5 nm² cross section), the mobility decreases monotonically with increasing spatial confinement and becomes virtually independent of the transverse electric field. This occurs primarily due to the increase in the field-independent, confinement-induced part of the SRS (6), and second due to the increase in intrasubband phonon scattering. In contrast to bulk MOSFETs, in which the SRS plays an important role only for high fields from the gate, electrons in very thin SiNWs are strongly influenced by the roughness regardless of the transverse field. This finding is important both for FETs with multiple gates, such as the FinFET, as well as for ungated ultrathin wires used for TE applications or interconnects.

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APPENDIX A: PHONON SCATTERING

1. Bulk acoustic phonon scattering rate

The electron wavefunction in subband \( n \), taking into account confinement along the \( y \) and \( z \) directions and free motion along \( x \), is

\[ \Psi_n(r) = \psi_n(y, z) e^{i k_y y}. \]  

(A1)

The displacement field \( \mathbf{u} \) due to longitudinal phonons in the second-quantization form can be written as

\[ \mathbf{u}(r) = \sum_q \sqrt{\frac{\hbar}{2 \rho \Omega \omega_q}} \left( a_q e^{i q r} + a_q^\dagger e^{-i q r} \right) \mathbf{e}_q, \]  

(A2)

where \( a_q \) and \( a_q^\dagger \) are the phonon annihilation and creation operators, respectively, \( \Omega \) is the volume, \( \rho \) is the density, and \( \mathbf{e}_q \) is the polarization vector. The perturbing potential which goes into the matrix element calculation is given by

\[ H_{ac} = \Xi_{ac} \nabla \cdot \mathbf{u}, \]  

(A3)

where \( \Xi_{ac} \) is the acoustic deformation potential and \( \mathbf{u} \) is the phonon displacement given by Eq. (A2).

From Eqs. (A2) and (A3), we can write the perturbing potential as

\[ H_{ac} = \Xi_{ac} \sum_q \sqrt{\frac{\hbar}{2 \rho \Omega \omega_q}} \mathbf{e}_q \cdot i \mathbf{q} (a_q e^{i q r} - a_q^\dagger e^{-i q r}). \]  

(A4)

The matrix element for scatter from subband \( n \) with wavevector \( \mathbf{k}_x \) to subband \( m \) with \( \mathbf{k}_x' \) is given by

\[ M_{nm} = \sqrt{\frac{\hbar}{2 \rho \Omega \omega_q}} q \left( N_q + \frac{1}{2} \right)^{1/2} \int \int \left[ \psi_n(y, z) e^{i (q_y y + q_z z)} \psi_m(y, z) \right] dy dz \times \frac{1}{L_x} \int e^{i (k_x - k_x') z} dz, \]  

(A5)

where \( N_q \) is the number of phonons given by the Bose–Einstein distribution function

\[ N_q = \frac{1}{e^{\hbar \Omega q} - 1}. \]  

(A6)

Defining \( I_{nm}(q_x, q_z) \) as

\[ I_{nm}(q_x, q_z) = \int \int \left[ \psi_n(y, z) e^{i (q_y y + q_z z)} \psi_m(y, z) \right] dy dz, \]  

(A7)

and after integrating over \( x \), Eq. (A5) yields

\[ |M_{nm}|^2 = \frac{\hbar}{2 \rho \Omega \omega_q} q^2 \left( N_q + \frac{1}{2} \right)^{1/2} \left( I_{nm} \right)^2 \delta(k_x - k_x' \pm q_x). \]  

(A8)

In the equipartition approximation, the phonon number becomes

\[ N_q = N_q + 1 \approx \frac{K_B T}{\hbar \omega_q}, \]  

(A9)

so using the equipartition approximation and linear dispersion relation for acoustic phonons defined by \( \omega_q = \nu q \) in Eq. (A8), we get
where \( n \) is the sound velocity in the crystal.

Adding a nonparabolicity factor \( \alpha \) and converting the \( dk' \) integration to \( dE' \) integration, the integral in Eq. (A14) simplifies to

\[
\mathcal{D}_{nm} = \int \int |\psi_n(y,z)|^2 |\psi_m(y,z)|^2 dydz.
\]

Using the identity

\[
\frac{1}{2 \pi} \int dq e^{i q (y-y')} = \delta(y-y'),
\]

we can write Eq. (A16) as

\[
\mathcal{D}_{nm} = \int \int |\psi_n(y,z)|^2 |\psi_m(y,z)|^2 dydz.
\]

Adding a nonparabolicity factor \( \alpha \) and converting the \( dk' \) integration to \( dE' \) integration, the integral in Eq. (A14) simplifies to

\[
\mathcal{D}_{nm} = \int \int |\psi_n(y,z)|^2 |\psi_m(y,z)|^2 dydz.
\]
ter absorption (top sign) and emission (bottom sign) of a phonon of energy $\hbar \omega_b$. Simplifying this using the approach followed in Appendix A 1, intervalley phonon scattering rate can be written as

$$\Gamma_{nm}(k,\omega) = \frac{\Xi_{ac}^2}{\sqrt{2\hbar \rho bo}} \left( \frac{N_{q_x} + \frac{1}{2} \pm \frac{1}{2}}{J_{n}} \right) \mathcal{L}_{nm}(J,\omega)$$

where the final kinetic energy $\epsilon_f$ is similar to that in Eq. (A20), with $\pm \hbar \omega_b$ to account for absorption (top sign) and emission (bottom sign) of a phonon.

3. Confined acoustic phonon scattering rate

Using the $xyz$ algorithm, the normalized displacement components for the $J_{th}$ acoustic phonon mode in terms of a complete set of basis functions $\Phi_n$ can be written as

$$u_{j} = \alpha_j \chi_{j,J}\Phi_n,$$

where $i=x,y,z$ represents one of the components of the displacement, $\alpha_j$ is the normalization constant, and $\chi_{j,J}$ are the coefficients of the basis functions. Taking the center of cross section of the wire as the origin, the basis functions in terms of powers of Cartesian coordinates in the lateral directions are

$$\Phi_n(x,y,z) = \left( \frac{2\pi}{W} \right)^{\frac{r}{2}} \exp(iq_n x) E_{\lambda}(x),$$

where $\lambda=(r,s)$, $q_n$ is the longitudinal wavevector of the acoustic phonon mode along the axis of the wire, $W$ and $H$ are the width and thickness of the wire, respectively.

Following the normalization procedure indicated in Ref. 32, we get the normalization constant in Eq. (A27) to be

$$\alpha_j = \frac{1}{\sqrt{\omega_j L_x}} \frac{1}{\sqrt{\omega_j \chi_{j,J}}}.$$

where $L_x$ is the length of the wire, $\omega_j$ is the frequency of the $J_{th}$ phonon mode, and $\chi_{j,J}$ is the eigenvector corresponding to $\omega_j$. $E$ is the matrix as defined in Ref. 32.

The acoustic phonon field, which is used to determine the perturbing potential, is given by

$$u = \sum_{J_i q_i} [a_{J_i q_i} u_{j_i} + \hat{a}_{J_i q_i}^{\dagger} u_{j_i}^{\hat{J}}] e^{iq_i r}.$$

(A30)

Considering Eq. (A30) instead of Eq. (A2) to represent the phonon displacement, the matrix element given by Eq. (A5) can be rewritten as

$$M_{nm}(k_x, k'_x) = \Xi_{ac} \alpha_j \left( N_{q_x} + \frac{1}{2} \pm \frac{1}{2} \right) \mathcal{L}_{nm}(J,\omega)$$

where $N_{q_x} = \{\exp[h \omega(q_x) / k_B T] - 1\}^{-1}$ is the number of acoustic phonons of energy $h \omega(q_x)$ and $\mathcal{L}_{nm}(J,\omega)$ is the electron phonon overlap integral given by

$$\mathcal{L}_{nm}(J,\omega) = \int \int \left[ \psi_n(y,z) \left( \frac{2\pi}{W} \right)^{\frac{r}{2}} \exp(iq_j x) E_{\lambda}(x) \right] dydz.$$

(A32)

The square of the matrix element is then given by

$$|M_{nm}(k_x, k'_x)|^2 = \Xi_{ac}^2 \left( N_{q_x} + \frac{1}{2} \pm \frac{1}{2} \right) \mathcal{L}_{nm}(J,\omega)^2 \delta(k_x - k'_x \pm q_x).$$

(A33)

Considering the confined acoustic phonon scattering to be inelastic, the scattering rate can now be written as

$$\Gamma_{nm}(k_x) = \frac{2\pi \Xi_{ac}^2}{H \rho W} \sum_{J_i q_i} \left( N_{q_x} + \frac{1}{2} \pm \frac{1}{2} \right) |\alpha_j|^2 \mathcal{L}_{nm}(J,\omega)$$

$$\times \delta(E - E' \pm \hbar \omega_j(q_x)), $$

(A34)

where the upper and lower signs denote absorption and emission of an acoustic phonon of energy $\hbar \omega_j(q_x)$, respectively. Integrating over $q_x$ and including the nonparabolicity factor, the scattering rate can be written as

$$\Gamma_{nm}(k_x) = \frac{\Xi_{ac}^2}{2WH} \sum_{J_i q_i} \int dq_x \left( N_{q_x} + \frac{1}{2} \pm \frac{1}{2} \right) |\alpha_j|^2 \mathcal{L}_{nm}(J,\omega)$$

$$\times \frac{1}{\omega_j(q_x) \chi_{j,J}^{\dagger} \chi_{j,J} |g(q)|^2} \delta(E - E' \pm \hbar \omega_j(q_x)), $$

(A35)

where the total energy of the electron before $E$ and after $(E')$ scattering are defined as

$$E = E_n + \frac{\sqrt{1 + 4\alpha^2 - 1}}{2\alpha} - \frac{2m}{m},$$

$$E' = E_n + \frac{\sqrt{1 + 4\alpha^2 - 1}}{2\alpha} + \frac{2m}{m}.$$

(A36)

The argument of the delta function in Eq. (A35) can have two roots. Using the identity for delta functions with multiple roots, the final expression for the scattering rate is

$$\Gamma_{nm}(k_x) = \frac{\Xi_{ac}^2}{2WH} \sum_{J_i q_i} \sum_{i=1,2} \left( N_{q_x} + \frac{1}{2} \pm \frac{1}{2} \right) \mathcal{L}_{nm}(J,\omega)$$

$$\times \frac{1}{\omega_j(q_x) \chi_{j,J}^{\dagger} \chi_{j,J} |g(q)|^2} |\mathcal{L}_{nm}(J,\omega)|^2,$$

(A37)

where $q_j = [E - E' \pm \hbar \omega_j(q_x)]$, $q_{1,2}$ are the two possible roots of $g(q) = 0$, and $g'(q_{1,2})$ are the de-
derivatives of \( g(q_e) \) with respect \( q_e \) evaluated at \( q_{e1} \) and \( q_{e2} \), respectively.

**APPENDIX B: SURFACE ROUGHNESS SCATTERING**

In a very simple model used to describe the SRS, the perturbing potential for the interface normal to the \( y \) direction is given by

\[
H_{\text{sr}} = e_0 \varepsilon_0 \varepsilon_r \Delta(x),
\]

where \( \Delta(x) \) is a random function which describes the deviation of the actual interface from the ideal flat interface and \( e_0 \varepsilon_0 \varepsilon_r \) is the field normal to the interface. The scattering matrix calculated using this perturbing potential is

\[
M_{nm}(k_x, k'_x) = e^2 \int [\psi_n(y, z) e_0 \varepsilon_0 \varepsilon_r \psi_m(y, z)] dy dz \times \frac{1}{L_x} \int \Delta(x) e^{i(k_x - k'_x) y} dx.
\]

(B2)

Defining the term in the double integral of the above equation as \( F_{nm} \), the square of the matrix element can be written as

\[
|M_{nm}(k_x, k'_x)|^2 = e^2 F_{nm}^2 \frac{1}{L_x} \int dx' \int dx \Delta(x) \Delta(x') e^{i(k_x - k'_x) y}.
\]

(B3)

The average value of the matrix element given by Eq. (B3) over many samples is actually used to calculate the SRS. The expectation value of the square of the matrix element is given by

\[
\langle |M_{nm}(k_x, k'_x)|^2 \rangle = e^2 F_{nm}^2 \frac{1}{L_x} \int dx' \int dx R(x') e^{i k_x y}.
\]

(B4)

where the correlation function \( R(x-x')=\langle \Delta(x) \Delta(x') \rangle \) depends only on the distance \( |x-x'| \), and \( q_x = (k_x - k'_x) \). Redefining \( (x-x') \) as \( x'' \) we get

\[
\langle |M_{nm}(k_x, k'_x)|^2 \rangle = e^2 F_{nm}^2 \frac{1}{L_x} \int dx'' R(x'') e^{i q_x y}.
\]

(B5)

Assuming exponentially correlated surface roughness \(44 \) defined by \( R(x) = \Delta^2 e^{-|x|/(\lambda \varepsilon_r)} \) in Eq. (B4), we get

\[
\langle |M_{nm}(k_x, k'_x)|^2 \rangle = e^2 F_{nm}^2 \frac{1}{L_x} \Delta^2 \int dx'' \frac{2 \sqrt{2 \lambda}}{q_x^2 + 2}.
\]

(B6)

The scattering rate due to the interface imperfections can now be written as

\[
\Gamma_{nm}^{\text{sr}}(k_x) = 2 \pi e^2 F_{nm}^2 \frac{\Delta^2}{L_x} \frac{2 \sqrt{2 \lambda}}{q_x^2 + 2} \delta(\varepsilon' - \varepsilon).
\]

(B7)

Converting the sum over \( k'_x \) to integral over \( dk'_x \), we get

\[
\Gamma_{nm}^{\text{sr}}(k_x) = 2 \pi e^2 F_{nm}^2 \frac{\Delta^2}{L_x} \frac{2 \sqrt{2 \lambda}}{q_x^2 + 2} \delta(\varepsilon' - \varepsilon).
\]

(B8)

Defining \( \varepsilon_0 = \sqrt{1 + 4 \alpha \varepsilon_0 - 1}/2 \alpha \) and redefining \( (q_x')^2 \) as

\[
2m/h^2 [\varepsilon_0 (1 + \alpha \varepsilon_0) \pm \varepsilon_0 (1 + \alpha \varepsilon_0)]^2,
\]

the final expression for SRS assuming nonparabolic bands can be written as

\[
\Gamma_{nm}^{\text{sr}}(k_x, \pm) = 2 \pi e^2 F_{nm}^2 \frac{\Delta^2}{h^2} [\mp \varepsilon_0 (1 + \alpha \varepsilon_0)]^2 \delta(\varepsilon' - \varepsilon).
\]

(B9)

Unlike the approach detailed above, the model of Ando et al. \(33 \) of interface roughness scattering accounts for deformation of both the wavefunction and potential due to the imperfection at the \( \text{Si} - \text{SiO}_2 \) interfaces. The matrix element including the perturbation to wavefunction and the potential using the model of Ando et al. is given by

\[
M_{nm}(k_x, k'_x) = \int dy dz \int dx \frac{e^{i k_x y}}{\sqrt{L}} \langle \psi_n(y + \Delta x, z) \psi_m(y + \Delta x, z) \rangle
\]

\[
\times \left[ H_0 + \Delta V(y + \Delta x, z) \right] \psi_n(y + \Delta x, z) - \psi_m(y, z) H_0 \psi_n(y, z) e^{i k_x y}.
\]

(B10)

where the unperturbed system is represented by the Hamiltonian \( H_0 \) and wavefunctions \( \psi_n(y, z) \) and \( \Psi_m(y, z) \), while the perturbed system’s Hamiltonian and wavefunctions are \( [H_0 + \Delta V(y + \Delta x, z)] \psi_n(y + \Delta x, z) \) and \( \psi_m(y + \Delta(x, z)) \), respectively. Calculating the scattering rate from this matrix element, we find that the final expression for the SRS is same as before except that we have additional wavefunction deformation terms in the SRS overlap integral \( F_{nm} \). The SRS overlap integral is given in Eq. (6).